

AC/DC LED Lighting DESIGN GUIDE

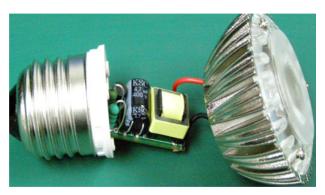
Jan 2010





GU10 1x1W LED Lighting

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT361	1	3.5V	1W	Flyback



Operation and Application

Figure 1 is the schematic of a offline LED driver using ACT361 to provide a power output of 3.5V, 350mA. This circuit is a typical flyback type power supply which includes the AC rectified circuit (BD1, C1), power drive circuit (BD pin, Q1), secondary rectified circuit (D2, C3) and the IC control circuit. ACT361 is a Primary Side Regulator (PSR) so that the power supply unit can regulate current and voltage without Opto-coupler. Pin 4 and Pin 2 are the VDD and ground pins to provide power for the IC. Pin 3 is the base driver for the NPN transistor. Pin 1 is the feedback pin that senses the output current and output voltage. Pin 6 is the peak current sense pin. Through a patented PSR technology,

this circuit can provide drivers for one (min), or two (max) LED lights in series due to the wide VDD operation ranges.

Key Component Selection

The turn ratio of the primary turn and the secondary turn (N_P/N_S), together with the R4 set the maximum output current value as shown in formula (1). The voltage setting is through the flyback voltage of auxiliary winding and the feedback resistor R5, R6 as shown in formula (2). $N_P/N_S/N_{AUX}$ (160/13/35) must be designed correctly to make sure it operates in DCM mode and it can supply either two or three LEDs in same circuit. A design value V_{OUTCV} equal to 3.5V and I_{OUTCC_MIN} equal to 350mA are used to do the design.

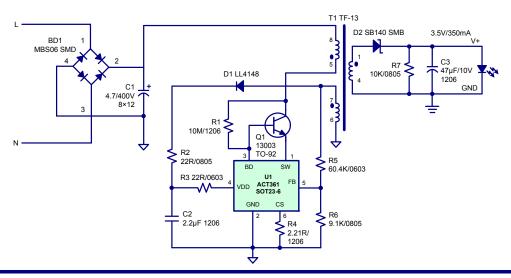
$$I_{OUTCC} = \frac{1}{2} \times L_P \times \left(\frac{0.396 \times 0.9}{R_{CS}}\right)^2 \times \left(\frac{\eta \times F_{SW}}{V_{OUTCV}}\right)$$
 (1)

 N_S and N_{AUX} are numbers of transformer secondary and auxiliary turns, and V_{SEC_R} is the rectifier diode forward drop voltage at approximately 0.1A bias.

$$V_{OUTCV} = V_{REF} \times (1 + \frac{R5}{R6}) \times \frac{N_S}{N_{AUX}} - V_{SEC_R}$$
 (2)

The peak current limit is set by (0.396×0.9) /R_{CS}.

Figure 1: Schematic of LED Lighting Driver



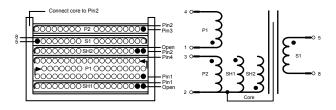
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Bill of Materials

REF.	DESCRIPTION	MFTR.
U1	IC, ACT361US-T, SOT23-6	Active- Semi
C1	Capacitor, Electrolytic, 4.7µF/400V, 8×12mm	KSC
C2	Capacitor, Ceramic, 2.2Fµ/35V, 1206, SMD	POE
C3	Capacitor, Ceramic, 47µF/10V, 1206, SMD	POE
BD1	Bridge Rectifier, 600V/1A, MBS06, SDIP	PANJIT
D1	General Rectifier, LL4148, 100V/1A	PANJIT
D2	Diode, Schottky, 40V/1A, SS14, SMA	PANJIT
Q1	Transistor, HFE 15-25, NPN, D13003X, TO-92	HUAWEI
R1	Chip Resistor, 10mΩ, 1206, 5%	TY-OHM
R2, R3	Chip Resistor, 22Ω, 0805, 5%	TY-OHM
R4	Chip Resistor, 2.21Ω, 1206, 1%	TY-OHM
R5	Chip Resistor, 60.4kΩ, 0805, 1%	TY-OHM
R6	Chip Resistor, 9.1kΩ, 0805, 1%	TY-OHM
R7	Chip Resistor, 10kΩ, 0805,5%	TY-OHM
T1	Transformer, L _P = 4.5mH, EE13	

Transformer Specification

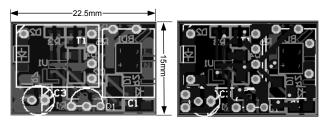


Build Up

	TERM	IINAL		TERMINAL WIRE			INSULATION	
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	NC	1	26	2UEW	0.12Ф×2	1	25µ/8.5mm	2
SH2	1	4	160	2UEW	0.12Ф×1	3	25µ/8.5mm	2
SH2	2	NC	26	2UEW	0.12Ф×2	1	25µ/8.5mm	2
S1	8	5	13	TEXE Reverse	0.3Ф×1	1	25μ/8.5mm	2
Р	3	2	35	2UEW	0.2Ф×1	1	25µ/8.5mm	2
SH2	Core	2	1	Copper Wire	0.18Ф×1	1	25μ/8.5mm	2

Note: P1 and P2 are Primary, S1 is Secondary (Bobbin: EE-13 Horizontal).

PCB Top and Bottom Layers

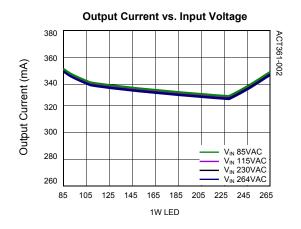


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 4 and pin 1 at 1VAC & 1kHz	4.5mH ± 7%
3	P1 Leakage Inductance	Inductance between pin 4 and pin 1 with pins 3-2 and 8-5 shorted	75µH

Typical performance Characteristics

Efficiency vs. Input Voltage 70 68 68 68 64 62 60 90 110 130 150 170 190 210 230 250 1W LED



EVALUATION KITS	V _{IN}	I ₀	LED(s)
ACT361UC-T-LED03	85-264VAC	280-350mA	1 or 2



E27 1x3W LED Lighting

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT361	1	4V	3W	Flyback



Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT361 to provide a power output of 4V, 650mA. This circuit is a typical flyback type power supply which includes the AC rectified circuit (BD1, L1, C2), primary snubber circuit (D1, R4, C2), power drive circuit (BD pin ,Q1), secondary rectified circuit (D3, C4) and the IC control circuit. ACT361 is a Primary Side Regulator (PSR) so that the power supply unit can regulate current and voltage without Opto-couple. Pin 4 and Pin 2 are the VDD and ground pins to provide power for the IC. Pin 3 is the base drive for the NPN transistor. Pin 1 is the switching pin. Pin 5 is the feedback pin that senses the output current and output voltage. Pin 6 is the peak current sense pin. Through a patented PSR

technology, this circuit can provide drivers for one 3W LED lights in series due to the wide VDD operation ranges.

Key Component Selection

The turn ratio of the primary turn and the secondary turn (N_P/N_S), together with the R6 set the maximum output current value as shown in formula (1). The voltage setting is through the flyback voltage of auxiliary winding and the feedback resistor R8, R9 as shown in formula (2). $N_P/N_S/N_{AUX}$ (168/12/30) must be designed correctly to make sure it operates in DCM mode and it can supply either two or three LEDs in same circuit. A design value V_{OUTCV} equal to 4V and I_{OUTCC_MIN} equal to 650mA are used to do the design.

$$I_{OUTCC} = \frac{1}{2} \times L_P \times \left(\frac{0.396 \times 0.9}{R_{CS}} \right)^2 \times \left(\frac{\eta \times F_{SW}}{V_{OUTCV}} \right)$$
 (1)

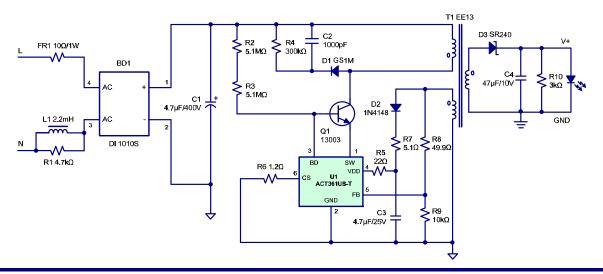
 N_S and N_{AUX} are numbers of transformer secondary and auxiliary turns, and V_{SEC_R} is the rectifier diode forward drop voltage at approximately 0.1A bias.

$$V_{OUTCV} = V_{REF} \times (1 + \frac{R8}{R9}) \times \frac{N_S}{N_{AUX}} - V_{SEC_R}$$
 (2)

The peak current limit is set by (0.396×0.9) /R_{CS}.

Figure 1:

Typical Application Circuit



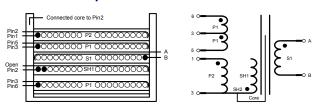
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Bill of Materials

	iviateriais	
REF.	DESCRIPTION	MFTR.
U1	IC, ACT361UC-T	Active- Semi
C1	Capacitor, Electrolytic, 4.7µF/400V, 8×12mm	KSC
C2	Capacitor, Ceramic, 1000pF/500V, 0805, SMD	POE
СЗ	Capacitor, Ceramic, 4.7μF/25V, 1206, SMD	POE
C4	Capacitor, Ceramic, 10µF/10V, 1206, SMD	POE
BD1	Bridge Rectifier, 1000V/1A, DI1010S, SDIP	PANJIT
D1	Diode, Ultra Fast, GS1M, 1000V/1.0A, SMA	PANJIT
D2	General Rectifier, LL4148, 100V/1A	PANJIT
D3	Diode, Schottky, 40V/2A, SR240, SMA	PANJIT
L1	Axial Inductor, 2.2mH, 0410, Dip	SoKa
FR1	Wire Round Resistor, 1W, 10Ω, KNP, 5%	TY-OHM
Q1	Transistor, HFE 15-25, NPN, D13003X, TO-92	Huawei
R1	Chip Resistor, 4.7kΩ, 0805, 5%	TY-OHM
R2, R3	Chip Resistor, 5.1MΩ, 0805, 5%	TY-OHM
R4	Chip Resistor, 300kΩ, 0805, 5%	TY-OHM
R5	Chip Resistor, 22Ω, 0805, 5%	TY-OHM
R6	Chip Resistor, 1.0Ω, 0805, 1%	TY-OHM
R7	Chip Resistor, 5.1Ω, 0805, 5%	TY-OHM
R8	Chip Resistor, 49.9kΩ, 0805,1%	TY-OHM
R9	Chip Resistor, 10kΩ, 0805, 1%	TY-OHM
R10	Chip Resistor, 3kΩ, 0805, 5%	TY-OHM
T1	Transformer, L _P = 2.6mH, EE13	

Transformer Specification

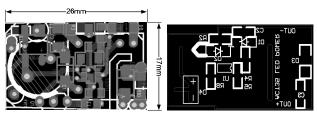


Build up

	TERMINAL		TERMINAL		TERMINAL		TERMINAL WIRE		INSULAT	INSULATION	
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER			
P1	6	3	84	2UEW	0.14Фх1	2	25µ/8.5mm	2			
SH1	2	Open	23	2UEW	0.13Фх2	1	25µ/8.5mm	2			
S1	В	Α	12	TEXE Reverse	0.3Фх1	1	25μ/8.5mm	2			
P1	3	5	84	2UEW	0.14Фх1	2	25µ/8.5mm	2			
P2	1	2	30	2UEW	0.15Фх4	1	25µ/8.5mm	2			
SH2	Core	2	1	Copper Wire	0.18Фх1	1	25μ/8.5mm	2			

P1 and P2 are Primary, S1 is Secondary (Bobbin: EE-13 Vertical)

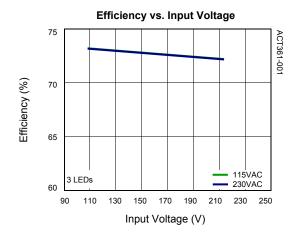
PCB Top and Bottom Layers

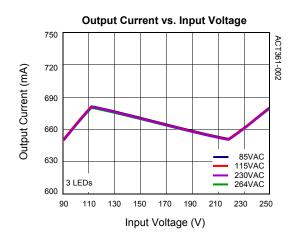


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 5 and pin 6 at 1VAC & 1kHz	2.6mH ± 7%
3	P1 Leakage Inductance	Inductance between pin 5 and pin 6 with pins 1-2 and A-B shorted	75µH

Typical Performance Characteristics





EVALUATION KITS	V _{IN}	I ₀	LED(s)
ACT361-LED02	85-264VAC	650-750mA	1



E27 3x1W LED Lighting

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT361	3	12V	3W	Flyback



Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT361 to provide a power output of 12V, 350mA. This circuit is a typical flyback type power supply which includes the AC rectified circuit (BD1, C1, L1, C2), primary snubber circuit (D1, R1, C3), power drive circuit (BD pin, Q1), secondary rectified circuit (D3, C5) and the IC control circuit. ACT361 is a Primary Side Regulator (PSR) so that the power supply unit can regulate current and voltage without Opto-coupler. Pin 4 and Pin 2 are the VDD and ground pins to provide power for the IC. Pin 3 is the base drive for the NPN transistor. Pin 1 is the switching pin. Pin 5 is the feedback pin that senses the output current and output voltage. Pin 6 is the

peak current sense pin. Through a patented PSR technology, this circuit can provide drivers for one 3W LED lights in series due to the wide VDD operation ranges.

Key Component Selection

The turn ratio of the primary turn and the secondary turn (N_P/N_S) , together with the R6 sets the maximum output current value as shown in formula (1). The voltage setting is through the flyback voltage of auxiliary winding and the feedback resistor R8, R9 as shown in formula (2). $N_P/N_S/N_{AUX}$ (130/15/17) must be designed correctly to make sure it operates in DCM mode and it can supply either two or three LEDs in same circuit. A design value V_{OUTCV} equal to 12V and I_{OUTCC_MIN} equal to 300mA are used to do the design.

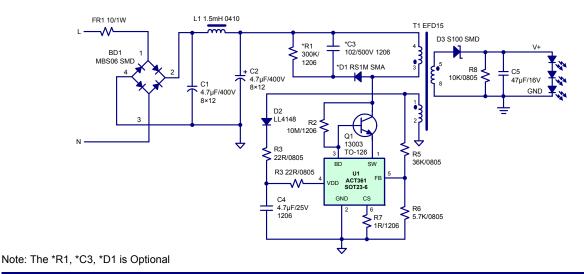
$$I_{OUTCC} = \frac{1}{2} \times L_P \times \left(\frac{0.396 \times 0.9}{R_{CS}}\right)^2 \times \left(\frac{\eta \times F_{SW}}{V_{OUTCV}}\right)$$
 (1)

 N_S and N_{AUX} are numbers of transformer secondary and auxiliary turns, and V_{SEC_R} is the rectifier diode forward drop voltage at approximately 0.1A bias.

$$V_{OUTCV} = V_{REF} \times (1 + \frac{R5}{R6}) \times \frac{N_{S}}{N_{AUX}} - V_{SEC_R}$$
 (2)

The peak current limit is set by (0.396×0.9)/R_{CS}.

Figure 1: Schematic of LED Lighting Driver



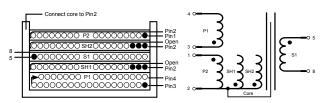
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Bill of Materials

REF.	DESCRIPTION	MFTR.
U1	IC, ACT361US-T, SOT23-6	Active- Semi
C1, C2	Capacitor, Electrolytic, 4.7µF/400V, 8×12mm	KSC
*C3	Capacitor, Ceramic, 1000pF/500V, 0805, SMD	POE
C4	Capacitor, Ceramic, 4.7µF/25V, 1206, SMD	POE
C5	Capacitor, Ceramic, 47μF/16V, 1206, SMD	POE
BD1	Bridge Rectifier, 600V/1A, MBS06, SDIP	PANJIT
*D1	Diode, Ultra Fast, GS1M, 1000V/1.0A, SMA	PANJIT
D2	General Rectifier, LL4148, 100V/1A	PANJIT
D3	Diode, Schottky, 100V/1A, S100, SMA	PANJIT
L1	Axial Inductor, 1.5mH, 0410, DIP	SOKA
FR1	Wire Round Resistor, 1W, 10Ω, KNP, 5%	TY-OHM
Q1	Transistor, HFE 15-25, NPN, D13003X, TO-92	HUAWEI
*R1	Chip Resistor, 300kΩ, 1206, 5%	TY-OHM
R2	Chip Resistor, 10mΩ, 1206, 5%	TY-OHM
R3, R4	Chip Resistor, 22Ω, 0805, 5%	TY-OHM
R5	Chip Resistor, 36kΩ, 0805, 1%	TY-OHM
R6	Chip Resistor, 5.7kΩ, 0805, 1%	TY-OHM
R7	Chip Resistor, 1.0Ω, 1206, 1%	TY-OHM
R8	Chip Resistor, 10kΩ, 0805, 5%	TY-OHM
T1	Transformer, L _P = 2.1mH, EFD15	

Transformer Specification

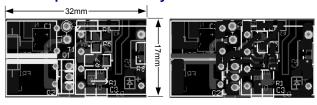


Build Up

	TERMINAL			WIRE			INSULATION	
WINDING		FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	3	4	130	2UEW	0.12Ф×1	2	25µ/8.5mm	2
SH1	2	Open	20	2UEW	0.12Ф×3	1	25µ/8.5mm	2
S1	8	5	15	TEXE Reverse	0.3Ф×1	1	25μ/8.5mm	2
P1	1	2	17	2UEW	0.12Ф×2	1	25µ/8.5mm	2
SH2	2	Open	20	2UEW	0.12Ф×3	1	25µ/8.5mm	2
SH2	Core	2	1	Copper Wire	0.18Ф×1	1	25μ/8.5mm	2

Note: P1 and P2 are Primary, S1 is Secondary (Bobbin: EFD-15 Horizontal).

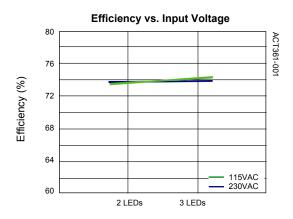
PCB Top and Bottom Layers

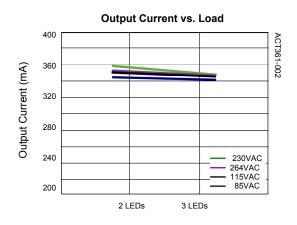


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 3 and pin 4 at 1VAC & 1kHz	2.1mH ± 7%
3	P1 Leakage Inductance	Inductance between pin 3 and pin 4 with pins 1-2 and 5-8 shorted	75µH

Typical Performance Characteristics





EVALUATION KITS	V _{IN}	I ₀	LED(s)
ACT361-LED05	85-264VAC	280-350mA	2 or 3



GU10 6x1W LED Lighting

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT361	6	26V	6W	Flyback



Operation and Application

Figure 1 is the schematic of a offline LED driver using ACT361 to provide a power output of 26V, 200mA. This circuit is a typical flyback type power supply which includes the AC rectified circuit (D1-D4, C1, C2), power drive circuit (BD pin, Q1), primary snubber circuit (D5, R3, C4), secondary rectified circuit (D7, C7, C8) and the IC control circuit. ACT361 is a Primary Side Regulator (PSR) so that the power supply unit can regulate current and voltage without Opto-coupler. Pin 4 and Pin 2 are the VDD and ground pins to provide power for the IC. Pin 3 is the base driver for the NPN transistor. Pin 1 is the switching pin. Pin5 is the feedback pin that senses the output current and

output voltage. Pin 6 is the peak current sense pin. Through a patented PSR technology, this circuit can provide drivers for four (min), or six (max) LED lights in series due to the wide VDD operation ranges.

Key Component Selection

The turn ratio of the primary turn and the secondary turn (N_P/N_S) , together with the R10 and R11 sets the maximum output current value as shown in formula (1). The voltage setting is through the flyback voltage of auxiliary winding and the feedback resistor R8, R9 as shown in formula (2). $N_P/N_S/N_{AUX}$ (140/20/11) must be designed correctly to make sure it operates in DCM mode and it can supply either two or three LEDs in same circuit. A design value V_{OUTCV} equal to 26V and I_{OUTCC_MIN} equal to 200mA are used to do the design.

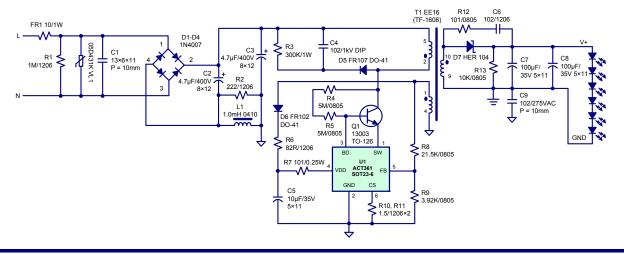
$$I_{OUTCC} = \frac{1}{2} \times L_P \times \left(\frac{0.396 \times 0.9}{R_{CS}}\right)^2 \times \left(\frac{\eta \times F_{SW}}{V_{OUTCV}}\right)$$
 (1)

 N_S and N_{AUX} are numbers of transformer secondary and auxiliary turns, and V_{SEC_R} is the rectifier diode forward drop voltage at approximately 0.1A bias.

$$V_{OUTCV} = V_{REF} \times (1 + \frac{R8}{R9}) \times \frac{N_S}{N_{AUX}} - V_{SEC_R}$$
 (2)

The peak current limit is set by (0.396×0.9) /R_{CS}.

Figure 1: Schematic of LED Lighting Driver



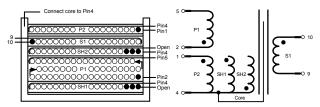
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Bill of Materials

REF.	DESCRIPTION	MFTR.
U1	IC, ACT361US-T, SOT23-6	Active-
	IC, AC130103-1, SO123-0	Semi
C1	Cap-X2 0.1µF 250V, 13×6×11mm, P=10mm	UTX
C2, C3	Capacitor Electrolytic, 4.7µF/400V, 8×12mm	KSC
C4	Capacitor Ceramic, 1000pF/1KV, Dip	POE
C5	Capacitor Electrolytic , 10µF/35V, 5×11mm	KSC
C6	Capacitor Ceramic, 1000pF/50V, 1206	POE
C7, C8	Capacitor Electrolytic, 100µF/35V, 5×11mm	KSC
C9	Y1 Capacitor, 1000pF/400VAC, DIP	POE
D1-D4	Rectifier, 1000V/1A, 1N4007, DO-41	Good-Ark
D5	Diode, Ultra Fast, FR107, 1000V/1.0A, DO-41	Good-Ark
D6	Diode, Ultra Fast, FR102,100V/1.0A, DO-41	Good-Ark
D7	Diode, Schottky, HER104, 300V/1A, DO-15	ST
L1	Axial Inductor, 1mH, 0410, DIP	SoKa
FR1	Wire Round Resistor, 1W, 10Ω, KNP, 5%	TY-OHM
Q1	Transistor, HFE 15-25, NPN, D13003X, TO-126	Huawei
VL1	Varistor, TVR05 431KSY, ¢ 5, 430V, ±10%, DIP	Thinking
R1	Chip Resistor, 1mΩ, 1206, 5%	TY-OHM
R2	Chip Resistor, 2.2kΩ,1206, 5%	TY-OHM
R3	Chip Resistor, 300kΩ, 1/2W, 5% DIP	TY-OHM
R4, R5	Chip Resistor, 5mΩ, 0805, 5%	TY-OHM
R6	Chip Resistor, 22Ω, 1206, 1%	TY-OHM
R7	Chip Resistor, 22Ω, 1/4W, 5% DIP	TY-OHM
R8	Chip Resistor, 21.5kΩ, 0805, 1%	TY-OHM
R9	Chip Resistor, 3.92kΩ, 0805, 1%	TY-OHM
R10, R11	Chip Resistor, 1.5Ω, 1206, 5%	TY-OHM
R12	Chip Resistor, 100Ω, 0805, 5%	TY-OHM
R13	Chip Resistor, 10kΩ, 0805, 5%	TY-OHM
T1	Transformer, L _P = 1.6mH, EE16	

Transformer Specification

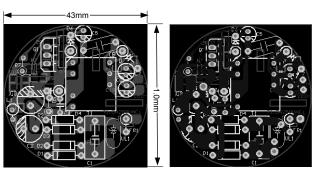


Build up

	TERMINAL				WIRE		INSULAT	ION
WINDING		FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
SH1	3	4	17	2UEW	0.12Ф×3	1	25µ/8.5mm	2
P1	2	5	140	2UEW	0.15Ф×1	3	25µ/8.5mm	2
SH2	4	NC	17	2UEW	0.12Ф×3	1	25µ/8.5mm	2
S1	9	10	20	TEXE Reverse	0.3Ф×1	2	25μ/8.5mm	2
Р	1	4	11	2UEW	0.2Φ×2	1	25µ/8.5mm	2
SH3	Core	4	1	Copper Wire	0.18Ф×1	1	25μ/8.5mm	2

Note: P1 and P2 are Primary, S1 is Secondary (Bobbin: EE-16 Vertical).

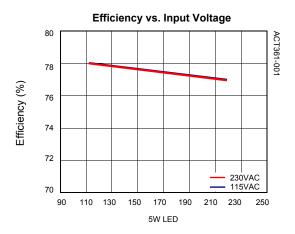
PCB Top and Bottom Layers

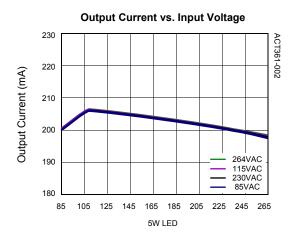


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pins 2 and pin 5 at 1VAC & 1kHz	1.6mH ± 7%
3	P1 Leakage Inductance	Inductance between pins 2 and pin 5 with pins 1-4 and 9-10 shorted	75µH

Typical performance Characteristics





EVALUATION KITS	V _{IN}	I ₀	LED(s)
ACT361UC-LED04	85-264VAC	180-230mA	4 or 6



16V, 5W, 350mA High Efficiency Solutions

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	4	16V	5W	Flyback

FEATURES

- Universal AC input
- High efficiency
- Constant Voltage Control & Short Circuit Protection
- CC temperature compensation
- ±5% current accuracy
- Exceed Energy Start 2.0 regulation
- Small SOT23-5 Package

APPLICATIONS

• Off-Line isolated LED Driver

Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 16V, 350mA. This circuit is a Flyback type power supply which includes the AC rectified circuit (D4, L1, C1, C2), power drive circuit (D9, R6, Q1), output rectified circuit (D10, C8) and the IC supply and control circuit. ACT50 is a very low cost peak

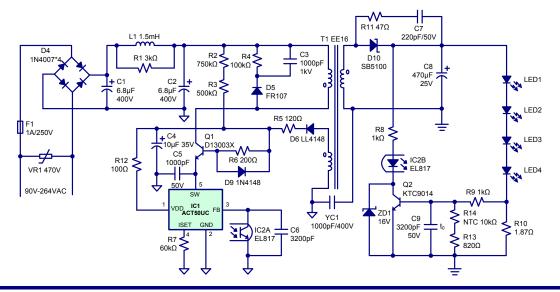
current control PWM controller. Constant voltage control is through OPTO couple and ZD1. Accurate current control is through R10 and the TC compensation circuit (C9, R14, R13).

Key Component Selection

The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be 20%-40% of the load current. A fast efficiency rectifier D10 is required to achieve higher efficiency. The turn ratio of secondary and auxiliary can be set as to make sure the V_{DD} in a working range. The serial output voltage V_0 should be in the range of 12V-16V voltage. The constant output current is set through R10 according formula (1). R14 is a thermal resistor to achieve good output current accuracy in high temperature. V_{BE} is 0.6V at 25°C and 0.55V at 50°C respectively.

$$V_{BE} = I_o \times R10 \times \frac{R14(T) + R13}{R14(T) + R13 + R9}$$
 (1)

Figure 1:
Typical Application Circuit



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Bill of Materials

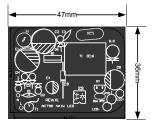
REF.	DESCRIPTION	MFTR.
IC1	IC, ACT50UC	Active- Semi
IC2	IC, EL817C, DIP-4	Everlight
C1, C2	Capacitor, Electrolytic, 6.8µF/400V, 8x12mm	KSC
C3	Capacitor, Ceramic, 1000pF/1kV, DIP	POE
C4	Capacitor, Electrolytic, 10µF/35V, 6.3x11mm	KSC
C5	Capacitor, Ceramic, 1000pF/50V, 0805, SMD	POE
C6, C9	Capacitor, Ceramic, 3200pF/50V, 0805, SMD	POE
C7	Capacitor, Ceramic, 220pF/50V, 1206, SMD	POE
C8	Capacitor, Electrolytic, 470µF/25V, 10x8mm	KSC
D1-D4	Diode, Ultra Fast, 1000V/1A 1N4007 DO-41	Good-Ark
D5	Diode, Ultra Fast, FR107, 1000V/1.0A, DO-41	Good-Ark
D6	Diode, Switching, 75V/150mA LL4148 MINI-MELF	Good-Ark
D9	Diode, Switching, 75V/150mA 1N4148, D0-15	Good-Ark
D10	Diode, Super Fast, SB5100, 100V/5.0A, DO-201AD	PANJIT
ZD1	Diode, Zener, GLZJ15A, 16V, 0.5W, MINI-MELF	PANJIT
L1	Axial Inductor, 1.5mH, 0410, DIP	Amode Tech
Q1	Transistor, NPN, 600V, 1.5A, D13003X, TO-26	Hua Wei
Q2	Transistor, NPN, KTC9014, TO-92	KEC
F1	Fuse:1A 250V 3.6x10mm With Pigtail	Walter
R1	Chip Resistor, 3kΩ, 0805, 5%	TY-OHM
R2	Chip Resistor, 750kΩ, 1206, 5%	TY-OHM
R3	Chip Resistor, 500kΩ, 1206, 5%	TY-OHM
R4	Chip Resistor, 100kΩ, 1/2W, 5%	TY-OHM
R5	Chip Resistor, 120Ω, 0805, 5%	TY-OHM
R6	Chip Resistor, 200Ω, 0805, 5%	TY-OHM
R7	Chip Resistor, 60kΩ, 0805, 1%	TY-OHM
R8, R9	Chip Resistor, 1kΩ, 0805, 5%	TY-OHM
R10	Meter Film Resistor, 1.87Ω, 1W DIP,1%	TY-OHM
R11	Chip Resistor, 47Ω, 1206, 5%	TY-OHM
R12	Chip Resistor, 100Ω, 1206, 5%	TY-OHM
R13	Chip Resistor, 820Ω, 0805, 5%	TY-OHM
R14	NTC Minus Thermistor Compensation $10k\Omega$, 5%	Thinking
VR1	Varistor, TVR05471KSY, ¢5, 470V, ±10%	Thinking
YC1	Y1 Capacitor, 1000pF/400V, DIP	UTX
T1	Transformer, L_P = 1.8mH, EE16	

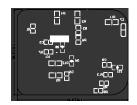
Build up

	•							
	TERM	IINAL			WIRE		INSULATI	ON
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	2	1	125	2UEW	0.15Фх1	3	25µ/8.5mm	2
SH1	1	Open	26	2UEW	0.15Фх2	1	25µ/8.5mm	2
S1	8	5	23	2UEW	0.4Фх1	1	25µ/8.5mm	2
SH2	3	Open	1.1	Copper	7mm	1	25µ/8.5mm	1
P2	4	3	21	2UEW	0.15Фх1	1	25µ/8.5mm	1

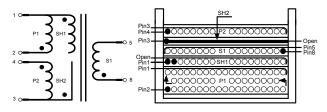
P1 and P2 are Primary, S1 is Secondary (Bobbin: EE-16 Horizontal)

PCB Top and Bottom Layers





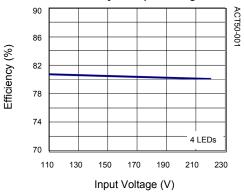
Transformer Specification

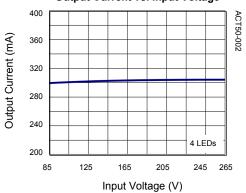


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 1 and pin 2 at 1VAC & 1kHz	1.8mH ±7%
3	P1 Leakage Inductance	Inductance between pin 1 and pin 2 with pins 3-4 and 5-8 shorted	75µH

Efficiency vs. Input Voltage





EVALUATION KITS	V _{IN}	l _o	LED(s)
ACT50UC-T-LED03	85-264VAC	280-350mA	3 or 4



49V, 5W, 128mA High Efficiency Solutions

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	14 Serial LED × 8 Line	49V	5W	Flyback

FEATURES

- Universal AC input
- High Efficiency
- Constant Voltage Control & Short Circuit Protection
- CC Temperature Compensation
- ±5% Current Accuracy
- Exceed Energy Start 2.0 Regulation
- Small SOT23-5 Package

APPLICATIONS

Off-Line isolated LED Driver

Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 49V, 128mA. This circuit is a flyback type power supply which includes the AC rectified circuit (D4, L1, C1, C2), power drive circuit (D9, R6, Q1), output rectified circuit (D10, C8) and the IC supply and control circuit. ACT50 is a very low cost peak

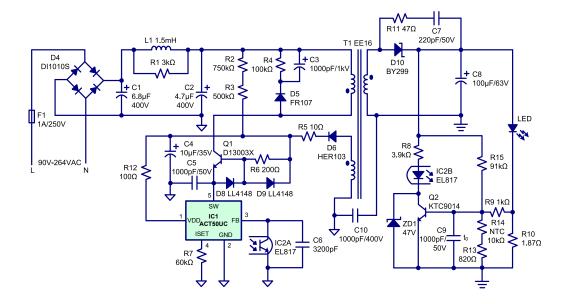
current control PWM controller. Constant voltage control is through OPTO couple and ZD1. Accurate current control is through R10 and the TC compensation circuit (R9, R13, R14).

Key Component Selection

The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be 20%-40% of the load current. A fast efficiency rectifier D10 is required to achieve higher efficiency. The turn ratio of secondary and auxiliary can be set as to make sure the V_{DD} in a working range. The serial output voltage V_0 should be in the range of 48V-52V voltage. The constant output current is set through R10 according formula (1). R14 is a thermal resistor to achieve good output current accuracy in high temperature. V_{BE} is 0.6V at 25°C and 0.55V at 50°C respectively.

$$V_{BE} = I_0 \times R10 \times \frac{R14(T) + R13}{R14(T) + R13 + R9}$$
 (1)

Figure 1:
Typical Application Circuit



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Bill of Materials

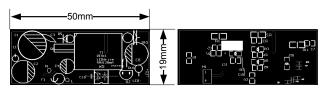
REF.	DESCRIPTION	MFTR.
IC1	IC, ACT50UC-T, SOT23-5	Active
IC2	IC, EL817C, DIP-4	Everlight
C1	Capacitor, Electrolytic, 6.8µF/400V, 10×12mm	KSC
C2	Capacitor, Electrolytic, 4.7µF/400V, 8×12mm	KSC
C3	Capacitor, Ceramic, 1000pF/1kV, DIP	POE
C4	Capacitor, Electrolytic, 10µF/35V, 5×11mm	KSC
C5	Capacitor, Ceramic, 1000pF/50V, 0805, SMD	POE
C6	Capacitor, Ceramic, 3300pF/50V, 0805, SMD	POE
C7	Capacitor, Ceramic, 220pF/50V, 1206, SMD	POE
C8	Capacitor, Electrolytic, 100µF/63V, 8×12mm	KSC
C9	Capacitor, Ceramic, 1000pF/50V, 0603, SMD	POE
C10	Safety Capacitor, Y2, 1000pF/400V, DIP	UTX
D4	Bridge Rectifier, 1000V/1A DI1010S, SDIP	PANJIT
D5	Diode, Ultra Fast, FR107, 1000V/1.0A, DO-41	Good-Ark
D6	Diode, Ultra Fast, HER103, 200V/1.0A, DO-41	Good-Ark
D8, D9	Diode, Switching, 75V/150mA LL4148 MINI-MELF	Good-Ark
D10	Diode, Super Fast, BY299, 800V/2.0A, DO-201AD	PANJIT
ZD1	Diode, Zener, GLZ47, 47V, 0.5W, MINI-MELF	Good-Ark
L1	Axial Inductor, 1.5mH, 0410, DIP	Amode Tech
Q1	Transistor, NPN, 600V, 1.5A, D13003X, TO-126	Hua Wei
Q2	Transistor, NPN, KTC9014, TO-92	KEC
F1	Fuse: 1A 250V 3.6×10mm With Pigtail	Walter
R1	Meter Film Resistor, 3kΩ, 0805, 5%	TY-OHM
R2	Chip Resistor, 750kΩ, 1206, 5%	TY-OHM
R3	Chip Resistor, 500kΩ, 0805, 5%	TY-OHM
R4	Chip Resistor, 100kΩ, 1206, 5%	TY-OHM
R5	Chip Resistor, 10Ω, 0805, 5%	TY-OHM
R6	Chip Resistor, 200Ω, 0805, 5%	TY-OHM
R7	Chip Resistor, 60kΩ, 0805, 1%	TY-OHM
R8	Chip Resistor, 3.9kΩ, 0805, 5%	TY-OHM
R9	Chip Resistor, 1kΩ, 0805, 5%	TY-OHM
R10	Meter Film Resistor, 1.87Ω, 1/2W DIP, 1%	TY-OHM
R11	Chip Resistor, 47Ω, 1206, 5%	TY-OHM
R12	Chip Resistor, 100Ω, 1206, 5%	TY-OHM
R13	Chip Resistor, 820Ω, 0603, 5%	TY-OHM
R14	NTC Minus Thermistor Compensation 10kΩ, 5%	Thinking
R15	Chip Resistor, 91kΩ, 0603, 5%	TY-OHM
T1	Transformer, L_P = 2.0mH, EE-16	

Build Up

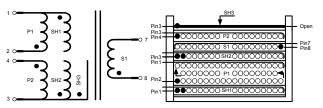
	TERMINAL				WIRE		INSULAT	ION
WINDING		FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
SH1	1	Open	26	2UEW	0.15Ф×2	1	25µ/8.5mm	2
P1	2	1	125	2UEW	0.15Ф×1	3	25µ/8.5mm	2
SH2	3	Open	26	2UEW	0.15Ф×2	1	25µ/8.5mm	2
S1	8	7	68	TEXE	0.3Ф×1	1	25µ/8.5mm	2
P2	4	3	21	2UEW	0.15Ф×1	1	25µ/8.5mm	3
SH3	3	Open	1.1	Copper	7mm	1	25µ/8.5mm	3

P1 and P2 are Primary, S1 is Secondary (Bobbin: EE-16 Horizontal)

PCB Top and Bottom Layers



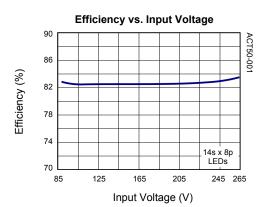
Transformer Specification

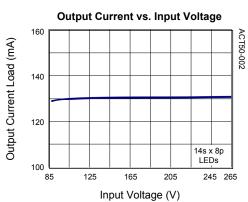


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 1 and pin 2 at 1VAC & 1kHz	
3	P1 Leakage Inductance	Inductance between pin 1 and pin 2 with pins 3-4 and 7-8 shorted	75µH

Typical Performance Characteristics





EVALUATION KITS	V _{IN}	I ₀	LED(s)
ACT50UC-T-LED05	85-264VAC	115-140mA	14s x 8p (8x16mA)



PAR30 7W LED Lighting

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	7	28V	7W	Flyback



Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 28V, 350mA. This circuit is a Flyback type power supply which includes the AC rectified circuit (BD1, L1, C1, C2), power drive circuit (D3, R6, Q1), output rectified circuit (D4, C8, C9) and the IC supply and control circuit. ACT50 is a very low cost peak current control PWM controller. Constant voltage control is through OPTO couple and ZD1. Accurate

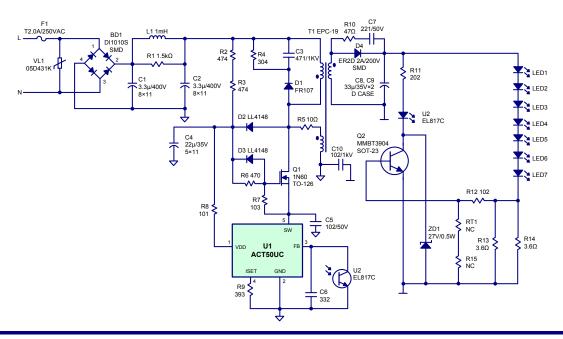
current control is through R13, R14 and the TC compensation circuit (RT1) R15.

Key Component Selection

The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be 20%-40% of the load current. A fast efficiency rectifier D4 is required to achieve higher efficiency. The turn ratio of secondary and auxiliary can be set as to make sure the V_{DD} in a working range. The serial output voltage V_0 should be in the range of 21V-28V voltage. The constant output current is set through R13, R14 according formula (1). RT1 is a thermal resistor to achieve good output current accuracy in high temperature. V_{BE} is 0.6V at 25°C and 0.55V at 50°C respectively.

$$V_{BE} = I_0 \times \frac{R13 \times R14}{R13 + R14} \times \frac{RT1 + R15}{RT1 + R12 + R15}$$
 (1)

Figure 1:
Typical Application Circuit



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Bill of Materials

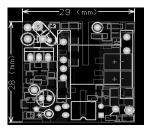
REF	DESCRIPTION	MFTR
U1	IC, ACT50UC, SOT23-5	Active
U2	IC, EL817C, DIP-4	Everlight
C1, C2	Capacitor Electrolytic, 3.3µF/400V, 8×12mm	KSC
C3	Capacitor Ceramic, 470pF/1KV, DIP	POE
C4	Capacitor Electrolytic, 22µF/35V, 5×11mm	KSC
C5	Capacitor Ceramic,1000pF/50V,0805	POE
C6	Capacitor Ceramic, 3300pF/25V,0603	POE
C7	Capacitor Ceramic, 220pF/50V,0805	POE
C8, C9	Capacitor Tantalum, 33µF/35V, D Case	AVX
C10	Capacitor Ceramic,1000pF/1KV, DIP	POE
BD1	Bridge Rectifier,1000V/1A, DI1010S, SDIP	PANJIT
D1	Diode, Ultra Fast, FR107, 1000V/1.0A, DO-41	Good-Ark
D2	Diode, Switching, 75V/150mA, LL4148, MICRO-MELF	Good-Ark
D3	Diode, Switching, 75V/150mA, LL4148, MICRO-MELF	Good-Ark
D4	Diode, Ultra Fast, ER2D, 200V/2.0A, SMD	PANJIT
ZD1	Diode, Zener, GMZJ27A ,27V, 0.5W, MICRO-MELF	PANJIT
Q1	Transistor, Mosfet, 1N60, TO-126	UTC
Q2	Amplifier Transistor, NPN, MMBT3904, SOT-23	
F1	Fuse: 2.0A 250V 3.6 × 10mm With Pigtail, Ceramic tube	Walter
L1	Axial Inductor, 1mH, 0410, DIP	Amode Tech
PCB1	ACT50 PCB, Ф18mm, T = 1.6mm, CEM-1, Rev: A	Jintong
PCB2	ACT50 PCB, L × W × T = 29 × 28 × 1.0mm, FR-4, Rev: A	Jintong
R1	Chip Resistor, 1.5kΩ,1206, 5%	TY-OHM
R2	Chip Resistor, 470kΩ,1206, 5%	TY-OHM
R3	Chip Resistor, 470kΩ,1206, 5%	TY-OHM
R4	Chip Resistor, 300kΩ,1206, 5%	TY-OHM
R5	Chip Resistor, 10Ω,1206, 5%	TY-OHM
R6	Chip Resistor, 47Ω,0805, 5%	TY-OHM
R7	Chip Resistor, 10kΩ,0805, 5%	TY-OHM
R8	Chip Resistor, 100Ω,0805, 5%	TY-OHM
R9	Chip Resistor, 39kΩ,0603, 1%	TY-OHM
R10	Chip Resistor, 47Ω,1206, 5%	TY-OHM
R11	Chip Resistor, 2.0kΩ,0603, 5%	TY-OHM
R12	Chip Resistor, 1kΩ,0603, 5%	TY-OHM
R13, R14	Chip Resistor, 3.6Ω,1206, 1%	TY-OHM
R15	NC	TY-OHM
RT1	NC	Thinking
T1	Transformer, L_P = 1.8mH, EPC-19	
VR1	Varistor, TVR05431KSY, ¢5, 430V, ±10%, DIP	Thinking

Build up

	TERMINAL			WIRE			INSULATION	
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	3	1	95	2UEW	0.25Φ×1	1	25μ/8.5mm	2
SH1	4	Open	40	2UEW	0.15Φ×2	1	25μ/8.5mm	2
S1	11	10	40	TEXE	0.45Φ×1	1	25µ/8.5mm	2
SH2	4	Open	0.9	Copper	7mm	1	25μ/8.5mm	2
P2	5	4	20	2UEW	0.15Φ×2	1	25μ/8.5mm	2
SH3	4	Open	1.1	Copper	7mm (Epiboly)	1	25μ/8.5mm	2

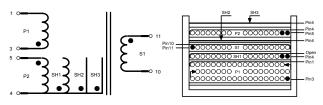
P1 and P2 are Primary, S1 is Secondary (Bobbin: EPC19 Horizontal)

PCB Layout





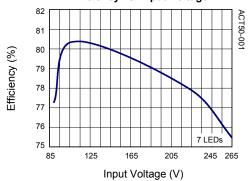
Transformer Specification

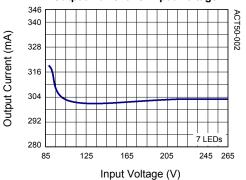


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from primary and secondary	3kVAC
2	P1 Inductance	Inductance between pins 1 and 3 at 1VAC & 1kHz	1.8mH ±7%
3	P1 Leakage Inductance	Inductance between pins 1 and 3 with pins 5-4 and 11-10 shorted	75µH

Efficiency vs. Input Voltage





EVALUATION KITS	V _{IN}	I ₀	LED(s)	
ACT50UC-T-LED04	85-264VAC	280-350mA	7	



35V, 12W, 350mA High Efficiency Solutions

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	10	35V	12W	Buck

FEATURES

- Universal AC input
- High efficiency
- Constant Voltage Control & Short Circuit Protection
- CC temperature compensation
- ±5% current accuracy
- Exceed Energy Start 2.0 regulation
- Small SOT23-5 Package

APPLICATIONS

Off-Line Non-isolated LED Driver

Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 35V, 350mA. This circuit is a buck type power supply which includes the AC rectified circuit (BD1, L1, C1, C2), power drive circuit (D9, R6, Q1), output rectified circuit (D10, C8, C9) and the IC supply and control circuit. ACT50 is a very low cost peak

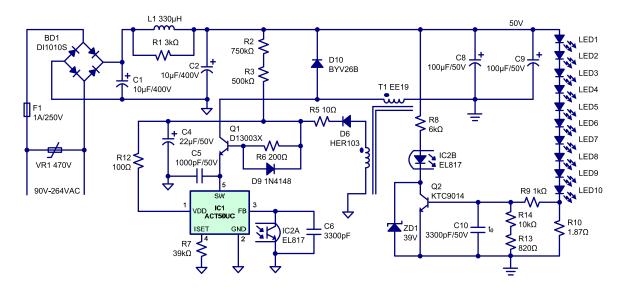
current control PWM controller. Constant voltage control is through OPTO couple and ZD1. Accurate current control is through R10 and the TC compensation circuit (R9, R14, R13).

Key Component Selection

The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be 20%-40% of the load current. A fast efficiency rectifier D10 is required to achieve higher efficiency. The turn ratio of primary and auxiliary can be set as to make sure the V_{DD} in a working range. The serial output voltage V_0 should be in the range of 35V-40V voltage. The constant output current is set through R10 according formula (1). R14 is a thermal resistor to achieve good output current accuracy in high temperature. V_{BE} is 0.6V at 25°C and 0.55V at 50°C respectively.

$$V_{BE} = I_o \times R10 \times \frac{R14(T) + R13}{R14(T) + R13 + R9}$$
 (1)

Figure 1: Typical Application Circuit

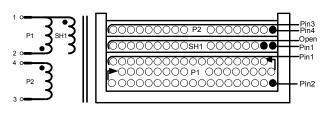


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Bill of Materials

REF.	DESCRIPTION	MFTR.
IC1	IC, ACT50UC	Active-
IC2		Semi
	IC, EL817C, DIP-4	Everlight
C1, C2	1 , 3 , 1 ,	KSC
C4	Capacitor, Electrolytic, 22µF/35V, 5x11mm	KSC
C5	Capacitor, Ceramic, 1000pF/50V, 0805, SMD	POE
	Capacitor, Ceramic, 3300pF/50V, 0805, SMD	POE
C8, C9	Capacitor, Electrolytic, 100µF/50V, 8x12mm	KSC
BD1	Bridge Rectifier, 1000V/1A, DI1010S, SDIP	Good-Ark
D6	Diode, Super Fast, HER103, 200V/1.0A, DO-41	PANJIT
D9	Diode, Switching, 75V/150mA 1N4148, DIP	Good-Ark
D10	Fast Efficient Rectifier, BYV26B, 500V/1A, DO-204AP	GS
ZD1	Diode, Zener, GLZ39A, 39V, 0.5W, MINI-MELF	Good-Ark
L1	Axial Inductor, 300μH, 0410, DIP	Amode Tech
Q1	Transistor, NPN, 600V, 1.5A, D13003X, TO-126	Hua Wei
Q2	Transistor, NPN, KTC9014, TO-92	KEC
F1	Fuse: 1A 250V 3.6 x 10mm With Pigtail	Walter
R1	Chip Resistor, 3kΩ, 0805, 5%	TY-OHM
R2	Chip Resistor, 750kΩ, 1206, 5%	TY-OHM
R3	Chip Resistor, 750kΩ, 1206, 5%	TY-OHM
R5	Chip Resistor, 10Ω, 0805, 5%	TY-OHM
R6	Chip Resistor, 200Ω, 0805, 5%	TY-OHM
R7	Chip Resistor, 39kΩ, 0805, 1%	TY-OHM
R8	Chip Resistor, 6kΩ, 0805, 5%	TY-OHM
R9	Chip Resistor, 1kΩ, 0805, 5%	TY-OHM
R10	Film Resistor, 1.87Ω, 1/2W DIP,1%	TY-OHM
R12	Chip Resistor, 100Ω, 1206, 5%	TY-OHM
R13	Chip Resistor, 820Ω, 0603, 5%	TY-OHM
R14	NTC Minus Thermistor Compensation $10k\Omega$, 5%	Thinking
VR1	Varistor, TVR05471KSY, ¢5, 470V, ±10%	Thinking
T1	Transformer, L _P = 2.6mH, EE-19	

Transformer Specification

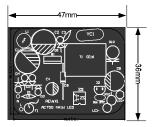


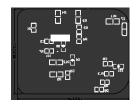
Build up

	TERMINAL			WIRE			INSULATION	
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	2	1	143	2UEW	0.3Ф×1	1	25µ/8.5mm	2
SH2	1	Open	30	2UEW	0.15Ф×2	1	25µ/8.5mm	2
P2	4	3	55	2UEW	0.15Ф×1	1	25µ/8.5mm	3

P1 and P2 are Primary, P2 is Secondary (Bobbin: EE-19 Horizontal)

PCB Top and Bottom Layers

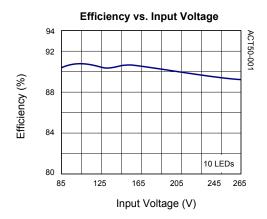


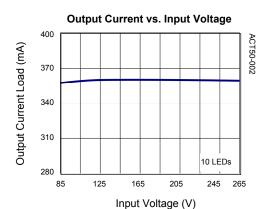


Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS		
1	Electrical Strength	Electrical Strength 50Hz, 1 minute, from Primary and Secondary			
2	P1 Inductance	P1 Inductance Inductance between pins 1 and 2 at 1VAC & 1kHz			
3	P1 Leakage Inductance	Inductance between pin 1 and pin 2 with pins 3-4 shorted	75µH		

Typical Performance Characteristics





EVALUATION KITS	V _{IN}	I ₀	LED(s)
ACT50UC-T-LED11	85-264VAC	280-350mA	9 or 10



PAR38 12W LED Lighting

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	12	42V	12W	Flyback



Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 42V, 350mA. This circuit is a Flyback type power supply which includes the AC rectified circuit (D1-D4, R1, C3, C4), power drive circuit (D10, R9, Q1), output rectified circuit (D11, C10, C11, C12), and the IC supply and control circuit. ACT50 is a very low cost peak current control PWM controller. Constant

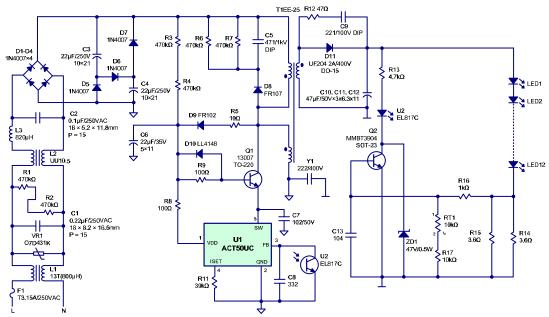
voltage control is through OPTO couple and ZD1. Accurate current control is through R14, R15, R16, and the TC compensation circuit (RT1, R17).

Key Component Selection

The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be designed to be 20%-40% of the load current. A fast efficiency rectifier D11 is required to achieve higher efficiency. The turn ratio of secondary and auxiliary can be set as to make sure the V_{DD} in a working range. The serial output voltage V_0 should be in the range of 42V-48V voltage. The constant output current is set through R14, R15 according formula (1). RT1 is a thermal resistor to achieve good output current accuracy in high temperature. V_{BE} is 0.6V at 25°C and 0.55V at 50°C respectively.

$$V_{BE} = I_o \times \frac{R14 \times R15}{R14 + R15} \times \frac{R71 + R17}{R71 + R16 + R17}$$
 (1)

Figure 1:
Typical Application Circuit

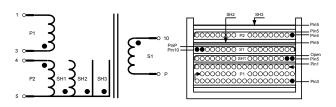


Jan 2010

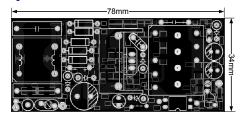
Bill of Materials

U2 IC, EL817C, DIP-4 Everlight C1 Cap-X2 0.22µF/250V,18x8.2x16.5mm, P=15mm UTX C2 Cap-X2 0.1µF/250V,18x5.2x11.8mm, P=15mm UTX C3-C4 Capacitor, Electrolytic, 22µF/400V, 10x21mm C5-C5 Capacitor, Ceramic, 470pF/1kV, DIP C6 Capacitor, Electrolytic, 22µF/35V, 5×11mm C7-C6 Capacitor, Ceramic, 1000pF/50V, 0805 C8 Capacitor, Ceramic, 3300pF/25V, 0805 C9 Capacitor, Ceramic, 220pF/1kV, DIP C10-C12 Capacitor, Electrolytic, 47µF/50V, 6.3×11mm C7-C13 Capacitor, Ceramic, 220pF/1kV, DIP C10-C12 Capacitor, Electrolytic, 47µF/50V, 6.3×11mm C13 Capacitor, Ceramic, 0.1µF/25V, 0805 C14 Capacitor, Ceramic, 0.1µF/25V, 0805 C15 Capacitor, Ceramic, 0.1µF/25V, 0805 C16 Capacitor, Ceramic, 0.1µF/25V, 0805 C17 Capacitor, Electrolytic, 47µF/50V, 6.3×11mm C18 Capacitor, Ceramic, 0.1µF/25V, 0805 C19 Capacitor, Ceramic, 0.1µF/25V, 0805 C10-C12 Capacitor, Ceramic, 0.1µF/25V, 0805 C11 Capacitor, Ceramic, 0.1µF/25V, 0805 C12 Capacitor, Ceramic, 0.1µF/25V, 0805 C13 Capacitor, Ceramic, 0.1µF/25V, 0805 C14 Capacitor, Ceramic, 0.1µF/25V, 0805 C15 Capacitor, Ceramic, 0.1µF/25V, 0805 C16 Capacitor, Ceramic, 0.1µF/25V, 0805 C17 Capacitor, Ceramic, 0.1µF/25V, 0805 C18 Capacitor, Ceramic, 0.1µF/25V, 0805 C19 Capacitor, Ceramic, 0.20pF/40VAC, DIP C10-C12 Capacitor, Ceramic, 0.1µF/25V, 0805 C19 Capacitor, Ceramic, 0.1µF/25V, 0805 C10 Capacitor, Ceramic, 0.1µF/25V, 0805 C10 Capacitor, Ceramic, 0.1µF/25V, 0805 C10 Capacitor, 0.1µF/25V, 0805 C10 Ca	REF.	DESCRIPTION	MFTR.					
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U2	U1	IC, ACT50						
C1 Cap-X2 0.22µF/250V,18x8.2x16.5mm, P=15mm	U2	IC FL817C DIP-4						
C2 Cap-X2 0.1µF/250V,18x5.2x11.8mm, P=15mm UTX C3-C4 Capacitor, Electrolytic, 22µF/400V, 10×21mm KSC C5 Capacitor, Ceramic, 470pF/1kV, DIP POE C6 Capacitor, Electrolytic, 22µF/35V, 5×11mm KSC C7 Capacitor, Ceramic, 1000pF/50V, 0805 POE C8 Capacitor, Ceramic, 3300pF/25V, 0805 POE C9 Capacitor, Ceramic, 220pF/1kV, DIP POE C10-C12 Capacitor, Electrolytic, 47µF/50V, 6.3×11mm KSC C13 Capacitor, Ceramic, 0.1µF/25V, 0805 POE C10-C12 Capacitor, Electrolytic, 47µF/50V, 6.3×11mm KSC C13 Capacitor, Ceramic, 0.1µF/25V, 0805 POE D1-D7 Rectifier, 1000V/1A, 1N4007 DO-41 Good-Ark D8 Diode, Ultra Fast, FR107, 1000V/1A DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark ZD1 Diode, Zener, GMZ,47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 F1 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820µH, 0410, DIP R1, R4, Chip Resistor, 470kΩ, 1206, 5% TY-OHM R5 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R10 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R11 Chip Resistor, 47kΩ, 0603, 5% TY-OHM R12 Chip Resistor, 47kΩ, 0603, 5% TY-OHM R13 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R14 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R15 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R16 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R11 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R12 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R13 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R14 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R15 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R16 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ,								
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C7 Capacitor, Ceramic, 1000pF/50V, 0805 C8 Capacitor, Ceramic, 3300pF/25V, 0805 C9 Capacitor, Ceramic, 220pF/1kV, DIP POE C10-C12 Capacitor, Electrolytic, 47μF/50V, 6.3×11mm KSC C13 Capacitor, Ceramic, 0.1μF/25V, 0805 POE Y1 Y1 Capacitor, 2200pF/400VAC, DIP D1-D7 Rectifier, 1000V/1A, 1N4007 DO-41 Good-Ark D8 Diode, Ultra Fast, FR107, 1000V/1A DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark ZD1 Diode, Zener, GMZJ47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 F1 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R8 Chip Resistor, 10Ω, 1206, 5% TY-OHM R9 Chip Resistor, 10Ω, 1206, 5% TY-OHM R11 Chip Resistor, 47Ω, 1206, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 47Ω, 1206, 5% TY-OHM R14 Chip Resistor, 47Ω, 1206, 5% TY-OHM R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 1kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10Ω, 0603, 5% TY-OHM R18 Chip Resistor, 10Ω, 0603, 5% TY-OHM R19 Chip Resistor, 10Ω, 0603, 5% TY-OHM R10 Chip Resistor, 10Ω, 0603, 5% TY-OHM R11 Chip Resistor, 10Ω, 0603, 5% TY-OHM R12 Chip Resistor, 10Ω, 0603, 5% TY-OHM R13 Chip Resistor, 10Ω, 0603, 5% TY-OHM R14 Chip Resistor, 10Ω, 0603, 5% TY-OHM R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 10Ω, 0603, 5% TY-OHM R17 Chip Resistor, 10Ω, 0603, 5% TY-OHM R18 Chip Resistor, 10Ω, 0603, 5% TY-OHM R19 Chip Resistor, 10Ω, 0603, 5% TY-OHM R10 Chip Resistor, 10Ω, 0603, 5% TY-OHM R17 Chip Resistor, 10Ω, 0603, 5% TY-OHM R18 Chip Resistor, 10Ω, 0603, 5% TY-OHM R19 Chip Resistor, 10Ω, 0603, 5% TY-OHM R10 Chip Resistor, 10Ω, 0603, 5% TY-OHM R10 Chip Resistor, 10Ω, 0603, 5% TY-OHM R10 Chip Resistor, 10Ω, 0603,								
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C9 Capacitor, Ceramic, 220pF/1kV, DIP POE C10-C12 Capacitor, Electrolytic, 47μF/50V, 6.3×11mm KSC C13 Capacitor, Ceramic, 0.1μF/25V, 0805 POE Y1 Y1 Capacitor, 2200pF/400VAC, DIP POE D1-D7 Rectifier, 1000V/1A, 1N4007 DO-41 Good-Ark D8 Diode, Ultra Fast, FR107, 1000V/1A DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark D11 Diode, Zener, GMZJ47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 F1 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R8 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R10 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 3βQΩ, 0805, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 47Ω, 1206, 5% TY-OHM R14, R15 Chip Film Resistor, 36Ω, 1206, 1% TY-OHM R15 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R16 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R11 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R12 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R14 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R11 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R12 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ,		· · · · · · · · · · · · · · · · · · ·						
C10-C12 Capacitor, Electrolytic, $47\mu F/50V$, $6.3\times11mm$ KSC C13 Capacitor, Ceramic, $0.1\mu F/25V$, 0805 POE Y1 Y1 Capacitor, $2200pF/400VAC$, DIP POE D1-D7 Rectifier, $1000V/1A$, $1N4007$ DO-41 Good-Ark D8 Diode, Ultra Fast, FR107, $1000V/1A$ DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, $100V/1A$ DO-41 Good-Ark D10 Diode, Switching, $75V/150mA$, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, $400V/2.0A$, DO-15 Good-Ark ZD1 Diode, Zener, GMZJ47A, $47V$, $0.5W$, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 F1 Fuse: $3.15A$ 250V $3.6\times10mm$ With Pigtail, Ceramic tube. L1 Inductor, $1000000000000000000000000000000000000$								
C13 Capacitor, Ceramic, 0.1μF/25V, 0805 POE Y1 Y1 Capacitor, 2200pF/400VAC, DIP POE D1-D7 Rectifier, 1000V/1A, 1N4007 DO-41 Good-Ark D8 Diode, Ultra Fast, FR107, 1000V/1A DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark ZD1 Diode, Zener, GMZJ47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 Walter F1 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. Walter L1 Inductor, T9×5×3C, R12kΩ 13T 800µH Walter L2 Inductor, LP = 28~40mH, Bobbin UU10.5 Walter L3 Axial Inductor, 820µH, 0410, DIP TY-OHM R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R5 Chip Resistor, 10Ω, 1206, 5% TY-OHM R8 Chip Resistor, 47Ω, 1206, 5% TY-OHM R12 <td></td> <td></td> <td></td>								
Y1Y1 Capacitor, 2200pF/400VAC, DIPPOED1-D7Rectifier, 1000V/1A, 1N4007 DO-41Good-ArkD8Diode, Ultra Fast, FR107, 1000V/1A DO-41Good-ArkD9Diode, Ultra Fast, FR102, 100V/1A DO-41Good-ArkD10Diode, Switching, 75V/150mA, LL4148Good-ArkD11Diode, Ultra Fast, UF204, 400V/2.0A, DO-15Good-ArkZD1Diode, Zener, GMZ,J47A, 47V, 0.5W, MICRO-MELFPANJITQ1Transistor, NPN, D13007, TO-220HuaweiQ2Amplifier Transistor, NPN, MMBT3904, SOT-23F1Fuse: $3.15A$ 250V 3.6×10 mm With Pigtail, Ceramic tube.WalterL1Inductor, $T9 \times 5 \times 3C$, R12kΩ 13T 800μHWalterL2Inductor, LP = 28~40mH, Bobbin UU10.5WalterL3Axial Inductor, 820μH, 0410, DIPR1, R4, R6, R7Chip Resistor, 470kΩ, 1206, 5%TY-OHMR5Chip Resistor, 10Ω, 1206, 5%TY-OHMR8Chip Resistor, 10Ω, 1206, 5%TY-OHMR9Chip Resistor, 47Ω, 1206, 5%TY-OHMR11Chip Resistor, 47Ω , 1206, 5%TY-OHMR12Chip Resistor, 47Ω , 1206, 5%TY-OHMR13Chip Resistor, 47Ω , 1206, 5%TY-OHMR14, R15Chip Resistor, 47Ω , 1206, 5%TY-OHMR16Chip Resistor, 47Ω , 1206, 5%TY-OHMR17Chip Resistor, 47Ω , 0603, 5%TY-OHMR17Chip Resistor, 10Ω , 0603, 5%TY-OHMR17Chip Resistor, 10Ω , 0603, 5%TY-OHMR11NTC minus Thermistor Compensation 10Ω ,								
D1-D7 Rectifier, 1000V/1A, 1N4007 DO-41 Good-Ark D8 Diode, Ultra Fast, FR107, 1000V/1A DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark D11 Diode, Zener, GMZJ47A, 47V, 0.5W, MICRO-MELF PANJIT Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R8 Chip Resistor, 10Ω, 1206, 5% TY-OHM R8 Chip Resistor, 10Ω, 1206, 5% TY-OHM R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 39kΩ, 0805, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 4.7kΩ, 0603, 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM Transformer EE-25, BobbinTF-2202 10Pin Vertical, L_P = 1.2mH NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5% VR1 Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm								
D8 Diode, Ultra Fast, FR107, 1000V/1A DO-41 Good-Ark D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark D11 Diode, Zener, GMZJ47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, $T9 \times 5 \times 3C$, $T1 \times 3C$ R12kΩ 13T 800μH L2 Inductor, $T1 \times 3C$ L3 Axial Inductor, $T1 \times 3C$ L3 Axial Inductor, $T1 \times 3C$ L6 Chip Resistor, $T1 \times 3C$ L6 Chip Resistor, $T1 \times 3C$ L7 Chip Resistor, $T1 \times 3C$ L7 Chip Resistor, $T1 \times 3C$ L8 Chip Resistor, $T1 \times 3C$ L9 Chip Resistor								
D9 Diode, Ultra Fast, FR102, 100V/1A DO-41 Good-Ark D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark ZD1 Diode, Zener, GMZ, J47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R8 Chip Resistor, 10Ω, 1206, 5% TY-OHM R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 39kΩ, 0805, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 47Ω, 1206, 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 10Ω, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM Transformer EE-25, BobbinTF-2202 10Pin Vertical, LP = 1.2mH NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5% TY-OHM Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Insulation Washer: Φ3mm								
D10 Diode, Switching, 75V/150mA, LL4148 Good-Ark D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark ZD1 Diode, Zener, GMZ,47A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R8 Chip Resistor, 10Ω, 1206, 5% TY-OHM R8 Chip Resistor, 47Ω, 1206, 5% TY-OHM R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 39kΩ, 0805, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 47Ω, 1206, 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM Transformer EE-25, BobbinTF-2202 10Pin Vertical, LP = 1.2mH RT1 NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5% TY-OHM Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Insulation Washer: Φ3mm								
D11 Diode, Ultra Fast, UF204, 400V/2.0A, DO-15 Good-Ark ZD1 Diode, Zener, GMZ. μ 7A, 47V, 0.5W, MICRO-MELF PANJIT Q1 Transistor, NPN, D13007, TO-220 Huawei Q2 Amplifier Transistor, NPN, MMBT3904, SOT-23 Fuse: 3.15A 250V 3.6×10mm With Pigtail, Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R8 Chip Resistor, 10Ω, 1206, 5% TY-OHM R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 47Ω, 1206, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 47Ω, 1206, 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 10Ω, 0603, 5% TY-OHM R17 Chip Resistor, 10Ω, 0603, 5% TY-OHM Transformer EE-25, BobbinTF-2202 10Pin Vertical, LP = 1.2mH RT1 NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5% TY-OHM Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Insulation Washer: Φ3mm								
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Q2Amplifier Transistor, NPN, MMBT3904, SOT-23F1Fuse: $3.15A 250V 3.6 \times 10mm$ With Pigtail, Ceramic tube.WalterL1Inductor, $T9 \times 5 \times 3C$, R12kΩ 13T 800μHWalterL2Inductor, LP = $28 \sim 40mH$, Bobbin UU10.5TY-OHML3Axial Inductor, $820\mu H$, 0410, DIPTY-OHMR1, R4, R6, R7Chip Resistor, $470k\Omega$, 1206, 5%TY-OHMR5Chip Resistor, 10Ω , 1206, 5%TY-OHMR9Chip Resistor, 47Ω , 1206, 5%TY-OHMR11Chip Resistor, 47Ω , 1206, 5%TY-OHMR12Chip Resistor, 47Ω , 1206, 5%TY-OHMR13Chip Resistor, 47Ω , 1206, 5%TY-OHMR14, R15Chip Film Resistor, 3.6Ω , 1206, 1%TY-OHMR16Chip Resistor, $1k\Omega$, 0603, 5%TY-OHMR17Chip Resistor, $10k\Omega$, 0603, 5%TY-OHMR11NTC minus Thermistor Compensation $10k\Omega$, ¢5mm, 5%TY-OHMVR1Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIPThinkingH/SHeat Sunk: JD-YI Series L=20mm, BlackJIEDAFor Q1Insulation Washer: Φ 3mm								
F1Fuse: $3.15A 250V 3.6 \times 10mm$ With Pigtail, Ceramic tube.WalterL1Inductor, $T9 \times 5 \times 3C$, $R12k\Omega 13T 800\mu H$ WalterL2Inductor, $LP = 28 \sim 40mH$, Bobbin UU10.5TY-OHML3Axial Inductor, $820\mu H$, 0410 , DIPTY-OHMR1, R4, R6, R7Chip Resistor, $470k\Omega$, 1206 , 5% TY-OHMR5Chip Resistor, 10Ω , 1206 , 5% TY-OHMR8Chip Resistor, 100Ω , 1206 , 5% TY-OHMR9Chip Resistor, 47Ω , 1206 , 5% TY-OHMR11Chip Resistor, $39k\Omega$, 0805 , 5% TY-OHMR12Chip Resistor, 47Ω , 1206 , 5% TY-OHMR13Chip Resistor, 47Ω , 1206 , 5% TY-OHMR14, R15 Chip Film Resistor, 3.6Ω , 1206 , 1% TY-OHMR16Chip Resistor, $1k\Omega$, 0603 , 5% TY-OHMR17Chip Resistor, $10k\Omega$, 1000			Tidawci					
Ceramic tube. L1 Inductor, T9×5×3C, R12kΩ 13T 800μH L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% R5 Chip Resistor, 10Ω, 1206, 5% R6 Chip Resistor, 10Ω, 1206, 5% R7 Chip Resistor, 10Ω, 1206, 5% R9 Chip Resistor, 47Ω, 1206, 5% R11 Chip Resistor, 39kΩ, 0805, 5% R12 Chip Resistor, 47Ω, 1206, 5% R13 Chip Resistor, 47Ω, 1206, 5% R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% R16 Chip Resistor, 1kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 1kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R11 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R12 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R15 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R16 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-								
L2 Inductor, LP = 28~40mH, Bobbin UU10.5 L3 Axial Inductor, 820μH, 0410, DIP R1, R4, R6, R7 Chip Resistor, 470kΩ, 1206, 5% R5 Chip Resistor, 10Ω, 1206, 5% R8 Chip Resistor, 10Ω, 1206, 5% R9 Chip Resistor, 47Ω, 1206, 5% R11 Chip Resistor, 39kΩ, 0805, 5% R12 Chip Resistor, 47Ω, 1206, 5% R13 Chip Resistor, 47Ω, 1206, 5% R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% R16 Chip Resistor, 1kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R11 Transformer EE-25, BobbinTF-2202 10Pin Vertical, L _P = 1.2mH RT1 NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5% VR1 Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm	F1		Walter					
L3Axial Inductor, 820μH, 0410, DIPR1, R4, R6, R7Chip Resistor, 470kΩ, 1206, 5%TY-OHMR5Chip Resistor, 10Ω, 1206, 5%TY-OHMR8Chip Resistor, 100Ω, 1206, 5%TY-OHMR9Chip Resistor, 47Ω, 1206, 5%TY-OHMR11Chip Resistor, 39kΩ, 0805, 5%TY-OHMR12Chip Resistor, 47Ω, 1206, 5%TY-OHMR13Chip Resistor, 4.7kΩ, 0603, 5%TY-OHMR14, R15 Chip Film Resistor, 3.6Ω, 1206, 1%TY-OHMR16Chip Resistor, 1kΩ, 0603, 5%TY-OHMR17Chip Resistor, 10kΩ, 0603, 5%TY-OHMR17NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5%TY-OHMVR1Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIPThinkingH/SHeat Sunk: JD-YI Series L=20mm, BlackJIEDAFor Q1Insulation Washer: Φ 3mm	L1	Inductor, T9×5×3C, R12kΩ 13T 800μH						
$\begin{array}{c} R1,R4,\\R6,R7 \end{array} \begin{tabular}{l} R1,R4,\\R6,R7 \\ R5 \begin{tabular}{l} Chip Resistor,470kΩ,1206,5\% \\ R8 \begin{tabular}{l} Chip Resistor,10Ω,1206,5\% \\ R9 \begin{tabular}{l} Chip Resistor,47Ω,1206,5\% \\ R11 \begin{tabular}{l} Chip Resistor,39kΩ,0805,5\% \\ R12 \begin{tabular}{l} Chip Resistor,47Ω,1206,5\% \\ R13 \begin{tabular}{l} Chip Resistor,47Ω,1206,5\% \\ R14 \begin{tabular}{l} Chip Resistor,47Ω,1206,5\% \\ R15 \begin{tabular}{l} Chip Resistor,4.7kΩ,0603,5\% \\ R16 \begin{tabular}{l} Chip Resistor,1kΩ,0603,5\% \\ R17 \begin{tabular}{l} Chip Resistor,1kΩ,0603,5\% \\ R17 \begin{tabular}{l} Chip Resistor,10kΩ,0603,5\% \\ R17 ta$		Inductor, LP = 28~40mH, Bobbin UU10.5						
R6, R7 Chip Resistor, 470kΩ, 1206, 5% TY-OHM R5 Chip Resistor, 10Ω, 1206, 5% TY-OHM R8 Chip Resistor, 100Ω, 1206, 5% TY-OHM R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 39kΩ, 0805, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 4.7kΩ, 0603, 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 1kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R18 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R19 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R10 Chip Resistor, 10kΩ, 06	L3	Axial Inductor, 820µH, 0410, DIP						
R8 Chip Resistor, 100Ω , 1206 , 5% TY-OHM R9 Chip Resistor, 47Ω , 1206 , 5% TY-OHM R11 Chip Resistor, $39k\Omega$, 0805 , 5% TY-OHM R12 Chip Resistor, 47Ω , 1206 , 5% TY-OHM R13 Chip Resistor, 47Ω , 1206 , 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω , 1206 , 1% TY-OHM R16 Chip Resistor, $1k\Omega$, 0603 , 5% TY-OHM R17 Chip Resistor, $1k\Omega$, 0603 , 5% TY-OHM R18 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R19 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R19 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R11 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R12 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R13 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R19 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM R10 Chip Resistor, $10k\Omega$, $10k\Omega$		Chip Resistor, 470kΩ, 1206, 5%	TY-OHM					
R9 Chip Resistor, 47Ω, 1206, 5% TY-OHM R11 Chip Resistor, 39kΩ, 0805, 5% TY-OHM R12 Chip Resistor, 47Ω, 1206, 5% TY-OHM R13 Chip Resistor, 4.7kΩ, 0603, 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω, 1206, 1% TY-OHM R16 Chip Resistor, 1kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R17 Chip Resistor, 10kΩ, 0603, 5% TY-OHM R11 Transformer EE-25, BobbinTF-2202 10Pin Vertical, $L_P = 1.2$ mH RT1 NTC minus Thermistor Compensation 10kΩ, ¢5mm, 5% TY-OHM VR1 Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm	R5	Chip Resistor, 10Ω, 1206, 5%	TY-OHM					
R11 Chip Resistor, $39k\Omega$, 0805 , 5% TY-OHM R12 Chip Resistor, 47Ω , 1206 , 5% TY-OHM R13 Chip Resistor, $4.7k\Omega$, 0603 , 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω , 1206 , 1% TY-OHM R16 Chip Resistor, $1k\Omega$, 0603 , 5% TY-OHM R17 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM T1 Transformer EE-25, BobbinTF-2202 $10Pin$ Vertical, $L_P = 1.2mH$ NTC minus Thermistor Compensation $10k\Omega$, $ $\phi$$ 5mm, 5% TY-OHM VR1 Varistor, TVR07431KSY, $ $\phi$$ 7, $ $430V$, $ $\pm 10\%$, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: $ $\Phi$$ 3mm	R8	Chip Resistor, 100Ω, 1206, 5%	TY-OHM					
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	R9	Chip Resistor, 47Ω, 1206, 5%	TY-OHM					
R13 Chip Resistor, $4.7k\Omega$, 0603 , 5% TY-OHM R14, R15 Chip Film Resistor, 3.6Ω , 1206 , 1% TY-OHM R16 Chip Resistor, $1k\Omega$, 0603 , 5% TY-OHM R17 Chip Resistor, $10k\Omega$, 0603 , 5% TY-OHM T1 Transformer EE-25, BobbinTF-2202 10Pin Vertical, $L_P = 1.2$ mH RT1 NTC minus Thermistor Compensation $10k\Omega$, $$\phi$$ 5mm, 5% TY-OHM VR1 Varistor, TVR07431KSY, $$\phi$$ 7, $430V$, $\pm 10\%$, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: $$\Phi$$ 3mm	R11	Chip Resistor, 39kΩ, 0805, 5%	TY-OHM					
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	R12	Chip Resistor, 47Ω, 1206, 5%	TY-OHM					
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	R13	Chip Resistor, 4.7kΩ, 0603, 5%	TY-OHM					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	R14, R15	Chip Film Resistor, 3.6Ω, 1206, 1%	TY-OHM					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	R16	Chip Resistor, 1kΩ, 0603, 5%	TY-OHM					
Vertical, $L_P = 1.2 mH$ RT1 NTC minus Thermistor Compensation $10k\Omega$, ¢5mm, 5% VR1 Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm	R17	Chip Resistor, 10kΩ, 0603, 5%	TY-OHM					
THOMM 10kΩ, ¢5mm, 5% VR1 Varistor, TVR07431KSY, ¢7, 430V, ±10%, DIP Thinking H/S Heat Sunk: JD-YI Series L=20mm, Black For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm	T1	Transformer EE-25, BobbinTF-2202 10Pin						
H/S Heat Sunk: JD-YI Series L=20mm, Black JIEDA For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm	RT1		TY-OHM					
For Q1 Silicon Insulation: TO-220 For Q1 Insulation Washer: Φ3mm	VR1							
For Q1 Insulation Washer: Φ3mm	H/S		JIEDA					
	For Q1	Silicon Insulation: TO-220						
	For Q1	Insulation Washer: Ф3mm						
TOT QT Fall Fleat Sciew+Spring Washer Ψ3×611111		Pan Head Screw+Spring washer Ф3×8mm						
For Q1 Nut Φ3								

Transformer Specification



PCB Layout



Build Up

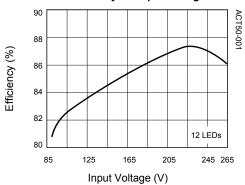
		IINAL			WIRE		INSULAT	ION
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	3	1	83	2UEW	0.25Φ×1	2	25μ/8.5mm	2
SH1	5	Open	40	2UEW	0.15Φ×2	1	25μ/8.5mm	2
S1	10	Р	41	TEXE	0.2Φ×2	1	25µ/8.5mm	2
SH2	5	Open	0.9	Copper	7mm	1	25µ/8.5mm	2
P2	4	5	12	2UEW	0.3Φ×1	1	25μ/8.5mm	2
SH3	5	Open	1.1	Copper	7mm (Core Outer)	1	25μ/8.5mm	2

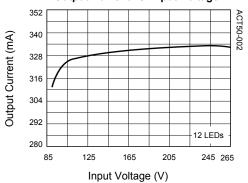
P1 and P2 are Primary, P1 is Secondary (Bobbin: EE-25 Horizontal)

Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 1 and pin 3 at 1VAC & 1kHz	1.2mH ±7%
3	P1 Leakage Inductance	Inductance between pin 1 and pin 3 with pins 5-4 and 10-P shorted	75µH

Efficiency vs. Input Voltage





EVALUATION KITS	V _{IN}	l ₀	LED(s)	
ACT50UC-T-LED06	85-264VAC	280-350mA	12	



35V, 12W, 350mA High Efficiency Solutions

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	10	35V	12W	Flyback

FEATURES

- Universal AC Input
- High Efficiency
- Constant Voltage Control & Short Circuit Protection
- CC Temperature Compensation
- ±5% Current Accuracy
- Exceed Energy Start 2.0 Regulation
- Small SOT23-5 Package

APPLICATIONS

Off-Line Isolated LED Driver

Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 35V, 350mA. This circuit is a flyback type power supply which includes the AC rectified circuit (D1-D4, L1, R1, C1, C2), power drive circuit (D9, R6, Q1), output rectified circuit (D10, C8, C9) and the IC supply and control circuit. ACT50 is a very low cost

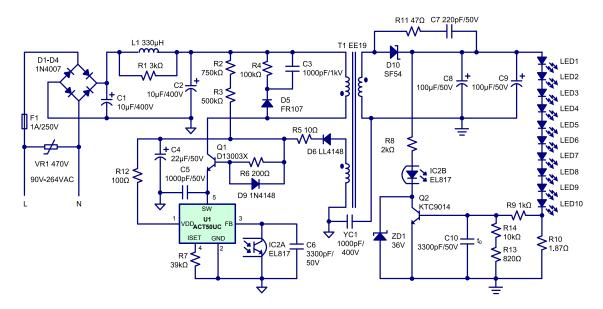
peak current control PWM controller. Constant voltage control is through OPTO coupler and ZD1. Accurate current control is through R10 and the TC compensation circuit (R9, R13, R14).

Key Component Selection

The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be 20%-40% of the load current. A fast efficiency rectifier D10 is required to achieve higher efficiency. The turn ratio of secondary and auxiliary can be set as 2.8 to make sure the $V_{\rm DD}$ in a working range. The serial output voltage V_0 should be in the range of 35V-40V voltage. The constant output current is set through R10 according formula (1). R14 is a thermal resistor to achieve good output current accuracy in high temperature. $V_{\rm BE}$ is 0.6V at 25°C and 0.55V at 50°C respectively.

$$V_{BE} = I_0 \times R10 \times \frac{R14(T) + R13}{R14(T) + R13 + R9}$$
 (1)

Figure 1:
Typical Application Circuit



Jan 2010

Bill of Materials

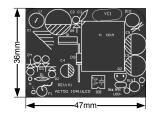
REF.	DESCRIPTION	MFTR.
IC1	IC, ACT50UC-T, SOT23-5	Active- Semi
IC2	IC, EL817C, DIP-4	Everlight
C1, C2	Capacitor, Electrolytic, 10µF/400V, 8×12mm	KSC
C3	Capacitor, Ceramic, 1000pF/1kV	POE
C4	Capacitor, Electrolytic, 22µF/50V, 5×11mm	KSC
C5	Capacitor, Ceramic, 1000pF/50V, 0805, SMD	POE
C6, C10	Capacitor, Ceramic, 3300pF/50V, 0805, SMD	POE
C7	Capacitor, Ceramic, 220pF/50V, 1206, SMD	POE
C8, C9	Capacitor, Electrolytic, 100µF/50V, 8×12mm	KSC
D1-D4	Diode, Ultra Fast, 1000V/1A 1N4007 DO-41	Good-Ark
D5	Diode, Ultra Fast, FR107, 1000V/1.0A, DO-41	Good-Ark
D6	Diode, Switching, 75V/150mA LL4148 MINI-MELF	Good-Ark
D9	Diode, Switching, 75V/150mA 1N4148, DO-15	Good-Ark
D10	Diode, Super Fast, SF54, 300V/3.0A, DO-201AD	Good-Ark
ZD1	Diode, Zener, GLZJ36A, 36V, 0.5W, MINI-MELF	Good-Ark
L1	Axial Inductor, 330μH, 0410, DIP	Amode Tech
Q1	Transistor, NPN, 600V, 1.5A, D13003X, TO-26	Hua Wei
Q2	Transistor, NPN, KTC9014, TO-92	KEC
F1	Fuse: 1A 250V 3.6×10mm With Pigtail	Walter
R1	Chip Resistor, 3kΩ, 0805, 5%	TY-OHM
R2	Chip Resistor, 750kΩ, 1206, 5%	TY-OHM
R3	Chip Resistor, 500kΩ, 0805, 5%	TY-OHM
R4	Chip Resistor, 100kΩ, 1206, 5%	TY-OHM
R5	Chip Resistor, 100Ω, 0805, 5%	TY-OHM
R6	Chip Resistor, 200Ω, 0805, 5%	TY-OHM
R7	Chip Resistor, 39kΩ, 0805, 1%	TY-OHM
R8	Chip Resistor, 2kΩ, 0805, 5%	TY-OHM
R9	Chip Resistor, 1kΩ, 0805, 5%	TY-OHM
R10	Meter Film Resistor, 1.87Ω, 1/2W DIP, 1%	TY-OHM
R11	Chip Resistor, 47Ω, 1206, 5%	TY-OHM
R12	Chip Resistor, 100Ω, 1206, 5%	TY-OHM
R13	Chip Resistor, 820Ω, 0603, 5%	TY-OHM
R14	NTC Minus Thermistor Compensation $10k\Omega$, 5%	Thinking
VR1	Varistor, TVR05471KSY, ¢5, 470V, ±10%	Thinking
YC1	Y1 Capacitor, 1000pF/400V, DIP	UTX
T1	Transformer, L_P = 1.8mH, EE19	

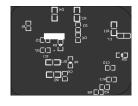
Build Up

	TERM	IINAL	NAL WIRE				INSULATION	
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
SH1	1	Open	30	2UEW	0.15Ф×2	1	25μ/8.5mm	2
P1	2	1	110	2UEW	0.25Ф×1	2	25μ/8.5mm	2
SH2	3	Open	30	2UEW	0.15Ф×2	1	25μ/8.5mm	2
S1	8	5	40	TEXE	0.45Ф×1	1	25μ/8.5mm	2
SH3	3	Open	1.1	Copper	7mm	1	25μ/8.5mm	3
P2	4	3	18	2UEW	0.15Ф×1	1	25μ/8.5mm	3

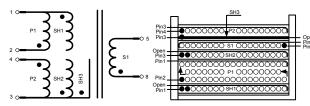
P1 and P2 are Primary, S1 is Secondary (Bobbin: EE-19 Horizontal)

PCB Top and Bottom Layers





Transformer Specification

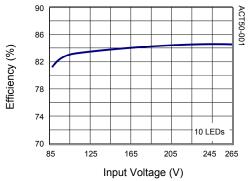


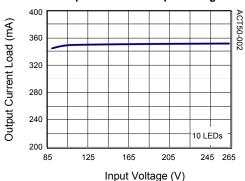
Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 1 and pin 2 at 1VAC & 1kHz	1.8mH ±7%
3	P1 Leakage Inductance	Inductance between pin 1 and pin 2 with pins 3-4 and 5-8 shorted	75µH

Typical Performance Characteristics

Efficiency vs. Input Voltage





EVALUATION KITS	V _{IN}	I ₀	LED(s)	
ACT50UC-T-LED07	85-264VAC	280-350mA	9 or 10	



28V, 21W, 350mA High Efficiency Solutions

Input Voltage	Device	LED(s)	Output Voltage	Power Output	Topology
85 - 264VAC	ACT50	7LED or 300mA or 600mA or 900mA	28V	21W	Buck

FEATURES

- Universal AC input
- High Efficiency
- Constant Voltage Control & Short Circuit Protection
- CC Temperature Compensation
- ±5% Current Accuracy
- Exceed Energy Start 2.0 Regulation
- Small DIP-8 Package

APPLICATIONS

Off-Line Isolated LED Driver

Operation and Application

Figure 1 is the schematic of an offline LED driver using ACT50 to provide a power output of 28V, 350mA. This circuit is a buck type power supply which includes the AC rectified circuit (D1-D7, L1-L3, C1-C5), power drive circuit (D10, R11, Q1), output rectified circuit (D11, C11, C12) and the IC supply and control circuit. ACT50 is a very low cost peak current control PWM controller. Constant

voltage control is through OPTO couple and D12. Accurate current control is through R13 and LM358 control circuit.

Key Component Selection

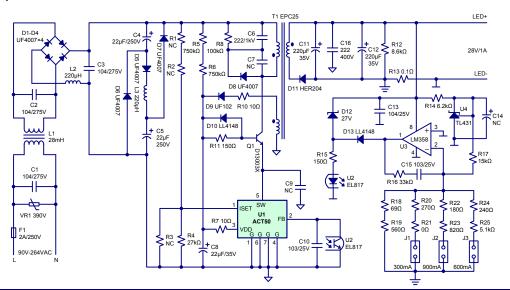
The inductance value is selected to enable to operate the circuit in the CCM mode. The ripple current can be designed to be 20%-40% of the load current. A fast efficiency rectifier D11 is required to achieve higher efficiency. The turn ratio of secondary and auxiliary can be set as to make sure the V_{DD} in a working range. The serial output voltage V_0 should be in the range of 28V-32V voltage. The constant output current is set through R13 according formula (1, 2, 3).

$$I_{01} = 2.5 \times \frac{(R18+R19)//(R20+R21)}{R17\times R13}$$
 (1)

$$I_{02} = 2.5 \times \frac{(R18+R19)/(R22+R23)}{R17 \times R13}$$
 (2)

$$I_{03} = 2.5 \times \frac{(R18+R19)/(R24+R25)}{R17\times R13}$$
 (3)

Figure 1:
Typical Application Circuit



Jan 2010

Bill of Materials

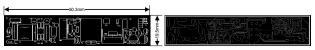
REF.	DESCRIPTION	MFTR.
U1	IC, ACT50UC-T, DIP-8	Active
U2	IC, EL817C, DIP-4	Everlight
U3	IC, LM358, DIP-8	Everlight
U4	IC, TL431, TO-92	USE
C1-C3	Capacitor-X2 0.1µF275V 18×6×12×15mm	UTX
C4, C5	Capacitor, Electrolytic, 22µF/250V, 10×20mm	KSC
C6	Capacitor, Ceramic, 2200pF/1kV, DIP	POE
C8	Capacitor, Electrolytic, 22µF/35V, 5×11mm	KSC
C10	Capacitor, Ceramic, 0.1µF/25V	POE
C11,C12	Capacitor, Electrolytic, 220pF/35V, 8×12mm	KSC
C13	Mul-Cap Ceramic, 0.1μF/25V, DIP	POE
C15	Mul-Cap Ceramic, 0.01µF/25V, DIP	POE
C16	Safety Capacitor, Y2, 2200pF/400V, P = 10mm, DIP	UTX
D1-D8	Diode, Ultra Fast, UF4007, 1000V/1.0A, DO-41	Good-Ark
D9	Diode, Ultra Fast, UF102, 200V/1.0A, DO-41	PANJIT
D10, D13	Diode, Switching, 75V/150mA, LL4148 MINI-MELF	Good-Ark
D11	Diode, Schottky, HER204, 300V/2A, DO-15	ST
D12	Diode, Zener, GDZJ27D, 27V, 0.5W, DO-35	PANJIT
L1	Inductor, UU10.5, 28mH	
L2, L3	3 Axial Inductor, 220µH, 0410, DIP	
Q1	Transistor, NPN, 600V, 1.5A, D13003X, TO-220	Hua Wei
F1	Fuse: 2A 250V 3.6×10mm with Pigtail	Walter
R4	Meter Film Resistor, 27kΩ, 1/4W, 1%	TY-OHM
R5, R6	Carbon Film Resistor, 750kΩ, 1/4W, 5%	TY-OHM
R7	Carbon Film Resistor, 10Ω, 1/4W, 5%	TY-OHM
R8	Carbon Film Resistor, 100kΩ, 1W, 5%	TY-OHM
R10	Carbon Film Resistor, 10Ω, 1/2W, 5%	TY-OHM
R11, 15	Carbon Film Resistor, 150Ω, 1/4W, 5%	TY-OHM
R12	Carbon Film Resistor, 8.6kΩ, 1/4W, 5%	TY-OHM
R13	Meter Film Resistor, 0.1Ω, 1/4W, 1%	TY-OHM
R14	Carbon Film Resistor, 6.2kΩ, 1/4W, 5%	TY-OHM
R16	Carbon Film Resistor, 33kΩ, 1/4W, 5%	TY-OHM
R17	Carbon Film Resistor, 15kΩ, 1/4W, 5%	TY-OHM
R18	Carbon Film Resistor, 69Ω, 1/4W, 5%	TY-OHM
R19	Carbon Film Resistor, 560Ω, 1/4W,5%	TY-OHM
R20	Carbon Film Resistor, 270Ω, 1/4W, 5%	TY-OHM
R21	Carbon Film Resistor, 0Ω, 1/4W, 5%	TY-OHM
R22	Carbon Film Resistor, 180Ω, 1/4W, 5%	TY-OHM
R23	Carbon Film Resistor, 820Ω, 1/4W,5%	TY-OHM
R24	Carbon Film Resistor, 240Ω, 1/4W, 5%	TY-OHM
R25	Carbon Film Resistor, 5.1kΩ, 1/4W, 5%	TY-OHM
VR1	TVR07391KSY ¢7, 390V ±10%	Thinking
T1	Transformer, $L_P = 0.8$ mH, EPC25	TY-OHM

Build up

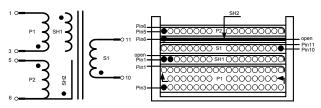
	•							
	TERMINAL			WIRE			INSULATION	
WINDING	START	FINISH	TURNS	TYPE	SIZE × QTY	LAYER	THICK/WIDE	LAYER
P1	3	1	87	2UEW	0.25Ф×1	1	25µ/8.5mm	2
SH1	1	Open	30	2UEW	0.15Ф×2	1	25µ/8.5mm	2
S1	10	11	28	TEXE	0.6Ф×1	1	25µ/8.5mm	2
SH2	6	Open	1.1	Copper	7mm	1	25µ/8.5mm	2
P2	5	6	14	2UEW	0.25Ф×1	1	25µ/8.5mm	2

P1 and P2 are Primary, S1 is Secondary (Bobbin: EPC25 Horizontal)

PCB Top and Bottom Layers



Transformer Specification

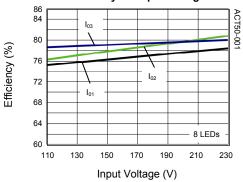


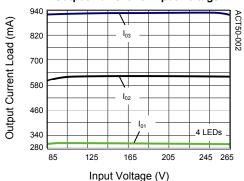
Electrical Specifications

ITEM	DESCRIPTION	CONDITION	LIMITS
1	Electrical Strength	50Hz, 1 minute, from Primary and Secondary	3kVAC
2	P1 Inductance	Inductance between pin 1 and pin 3 at 1VAC & 1kHz	0.8mH ±7%
3	P1 Leakage Inductance	Inductance between pin 1 and pin 3 with pins 5-6 and 10-11 shorted	75µH

Typical Performance Characteristics

Efficiency vs. Input Voltage





EVALUATION KITS	V _{IN}	l ₀	LED(s)	
		I ₀₁ 350mA±5%	7×300mA, or	
ACT50DH-LED08	85-264VAC	I ₀₂ 600mA±5%	7×600mA, oi	
		I ₀₃ 900mA±5%	7×900mA	